

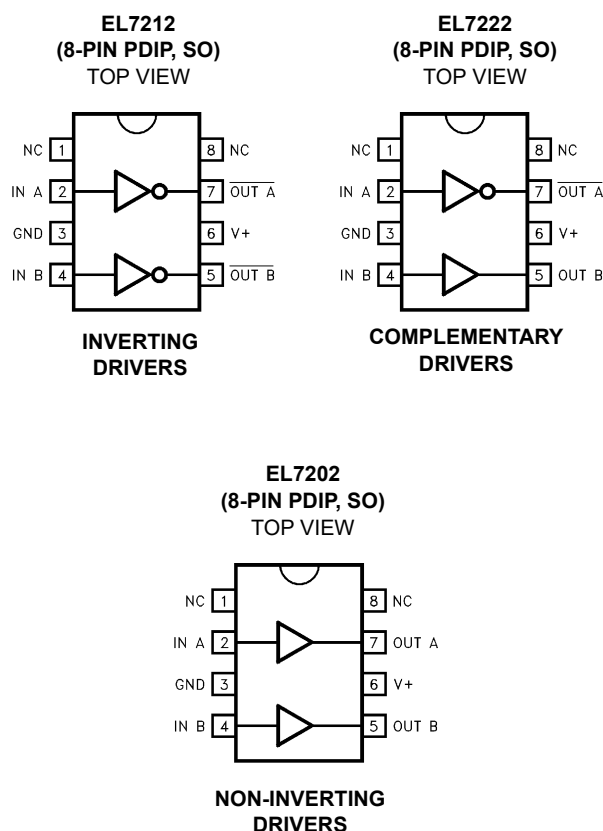
# EL7202, EL7212, EL7222

High Speed, Dual Channel Power MOSFET Drivers

FN7282  
Rev.2.01  
Feb 18, 2020

The EL7202, EL7212, EL7222 ICs are matched dual-drivers that improve the operation of the industry standard DS0026 clock drivers. The Elantec versions are very high speed drivers capable of delivering peak currents of 2.0 amps into highly capacitive loads. The high speed performance is achieved by means of a proprietary "Turbo-Driver" circuit that speeds up input stages by tapping the wider voltage swing at the output. Improved speed and drive capability are enhanced by matched rise and fall delay times. These matched delays maintain the integrity of input-to-output pulse-widths to reduce timing errors and clock skew problems. This improved performance is accompanied by a 10 fold reduction in supply currents over bipolar drivers, yet without the delay time problems commonly associated with CMOS devices. Dynamic switching losses are minimized with non-overlapped drive techniques.

## Pinouts



Manufactured under U.S. Patent Nos. 5,334,883, #5,341,047

## Features

- Industry standard driver replacement
- Improved response times
- Matched rise and fall times
- Reduced clock skew
- Low output impedance
- Low input capacitance
- High noise immunity
- Improved clocking rate
- Low supply current
- Wide operating voltage range
- Pb-Free available (RoHS compliant)

## Applications

- Clock/line drivers
- CCD Drivers
- Ultra-sound transducer drivers
- Power MOSFET drivers
- Switch mode power supplies
- Class D switching amplifiers
- Ultrasonic and RF generators
- Pulsed circuits

## Ordering Information

| Part Number                                                        | PART MARKING | TAPE & REEL | PACKAGE                 | PKG. DWG. # |
|--------------------------------------------------------------------|--------------|-------------|-------------------------|-------------|
| EL7202CN (No longer available, recommended replacement: EL7202CSZ) | EL7202CN     | -           | 8 Ld PDIP               | E8.3        |
| EL7202CSZ<br>(See Note)                                            | 7202CSZ      | -           | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7202CSZ-T7<br>(See Note)                                         | 7202CSZ      | 7"          | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7202CSZ-T13 (See Note)                                           | 7202CSZ      | 13"         | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7212CNZ                                                          | EL7212CN Z   | -           | 8 Ld PDIP*<br>(Pb-free) | E8.3        |
| EL7212CSZ<br>(See Note)                                            | 7212CSZ      | -           | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7212CSZ-T7<br>(See Note)                                         | 7212CSZ      | 7"          | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7212CSZ-T13<br>(See Note)                                        | 7212CSZ      | 13"         | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7222CSZ<br>(See Note)                                            | 7222CSZ      | -           | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7222CSZ-T7<br>(See Note)                                         | 7222CSZ      | 7"          | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |
| EL7222CSZ-T13<br>(See Note)                                        | 7222CSZ      | 13"         | 8 Ld SOIC<br>(Pb-free)  | M8.15E      |

NOTE: Pb-free products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

\*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

**Absolute Maximum Ratings** ( $T_A = 25^\circ\text{C}$ )

Supply ( $V_+$  to Gnd) ..... 16.5V  
 Input Pins ..... -0.3V to +0.3V above  $V_+$   
 Combined Peak Output Current ..... 4A  
 Storage Temperature Range .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$   
 Ambient Operating Temperature .....  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$

Operating Junction Temperature .....  $125^\circ\text{C}$   
 Power Dissipation  
     SOIC ..... 570mW  
     PDIP ..... 1050mW

*CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.*

*IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$*

## DC Electrical Specifications

 $T_A = 25^\circ\text{C}$ ,  $V = 15\text{V}$  unless otherwise specified

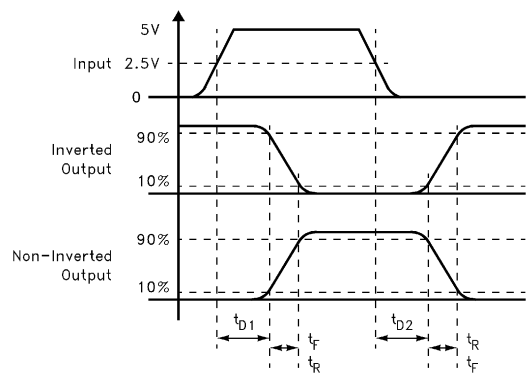
| parameter           | Description               | Test Conditions                                                | Min | Typ             | Max               | Units         |
|---------------------|---------------------------|----------------------------------------------------------------|-----|-----------------|-------------------|---------------|
| <b>INPUT</b>        |                           |                                                                |     |                 |                   |               |
| $V_{IH}$            | Logic "1" Input Voltage   |                                                                | 2.4 |                 |                   | V             |
| $I_{IH}$            | Logic "1" Input Current   | @ $V_+$                                                        |     | 0.1             | 10                | $\mu\text{A}$ |
| $V_{IL}$            | Logic "0" Input Voltage   |                                                                |     |                 | 0.8               | V             |
| $I_{IL}$            | Logic "0" Input Current   | @0V                                                            |     | 0.1             | 10                | $\mu\text{A}$ |
| $V_{HVS}$           | Input Hysteresis          |                                                                |     | 0.3             |                   | V             |
| <b>OUTPUT</b>       |                           |                                                                |     |                 |                   |               |
| $R_{OH}$            | Pull-Up Resistance        | $I_{OUT} = -100\text{mA}$                                      |     | 3               | 6                 | $\Omega$      |
| $R_{OL}$            | Pull-Down Resistance      | $I_{OUT} = +100\text{mA}$                                      |     | 4               | 6                 | $\Omega$      |
| $I_{PK}$            | Peak Output Current       | Source<br>Sink                                                 |     | 2<br>2          |                   | A             |
| $I_{DC}$            | Continuous Output Current | Source/Sink                                                    | 100 |                 |                   | mA            |
| <b>POWER SUPPLY</b> |                           |                                                                |     |                 |                   |               |
| $I_S$               | Power Supply Current      | Inputs High/EL7202<br>Inputs High/EL7212<br>Inputs High/EL7222 |     | 4.5<br>1<br>2.5 | 7.5<br>2.5<br>5.0 | mA            |
| $V_S$               | Operating Voltage         |                                                                | 4.5 |                 | 15                | V             |

## AC Electrical Specifications

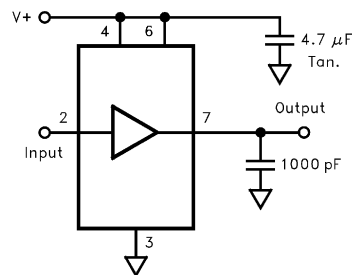
 $T_A = 25^\circ\text{C}$ ,  $V = 15\text{V}$  unless otherwise specified

| parameter                        | Description         | Test Conditions                               | Min | Typ       | Max | Units |
|----------------------------------|---------------------|-----------------------------------------------|-----|-----------|-----|-------|
| <b>SWITCHING CHARACTERISTICS</b> |                     |                                               |     |           |     |       |
| $t_R$                            | Rise Time           | $C_L = 500\text{pF}$<br>$C_L = 1000\text{pF}$ |     | 7.5<br>10 | 20  | ns    |
| $t_F$                            | Fall Time           | $C_L = 500\text{pF}$<br>$C_L = 1000\text{pF}$ |     | 10<br>13  | 20  | ns    |
| $t_{D1}$                         | Turn-On Delay Time  | See Timing Table                              |     | 18        | 25  | ns    |
| $t_{D2}$                         | Turn-Off Delay Time | See Timing Table                              |     | 20        | 25  | ns    |

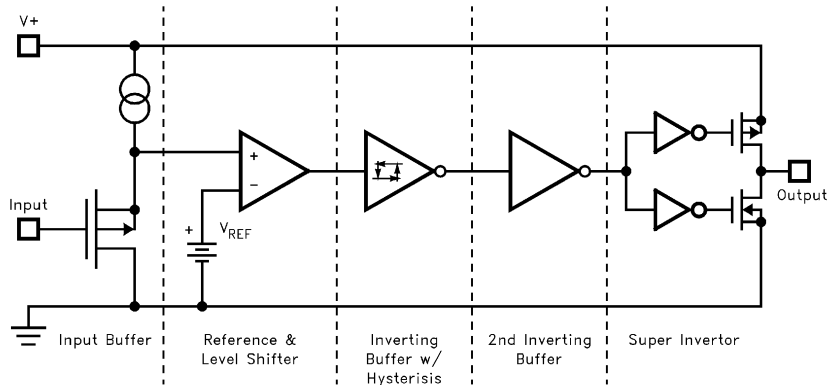
Timing Table



Standard Test Configuration

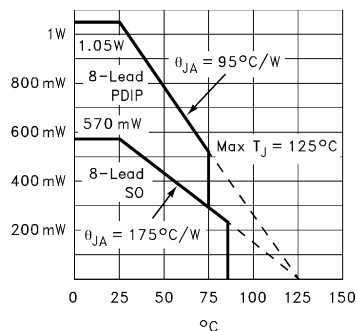


Simplified Schematic

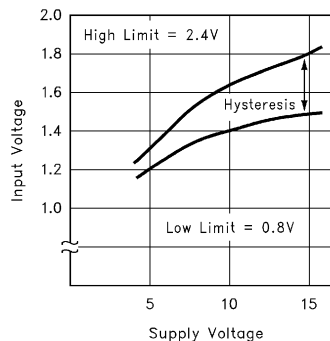


## Typical Performance Curves

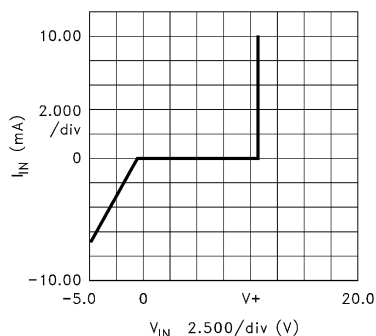
MAX POWER/DERATING CURVES



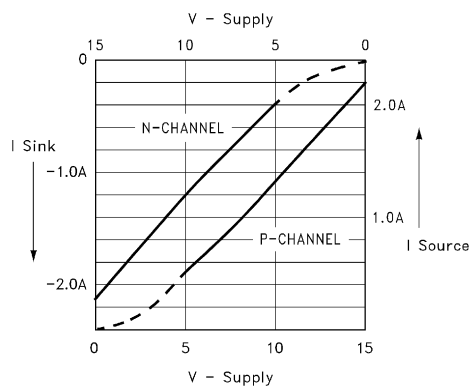
SWITCH THRESHOLD vs SUPPLY VOLTAGE



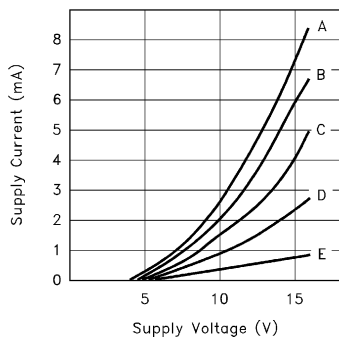
INPUT CURRENT vs VOLTAGE



PEAK DRIVE vs SUPPLY VOLTAGE



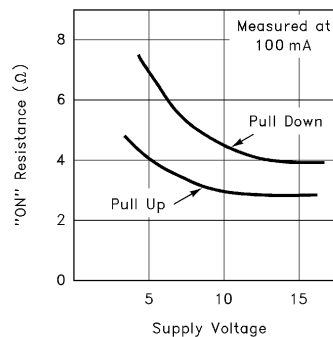
QUIESCENT SUPPLY CURRENT



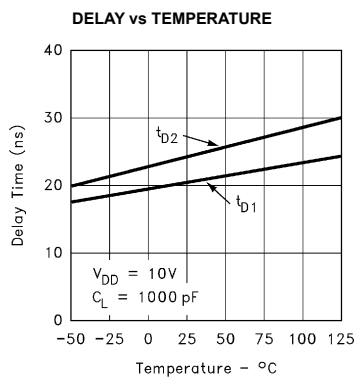
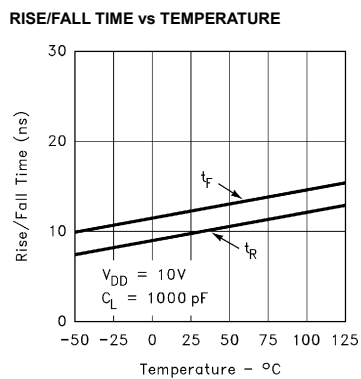
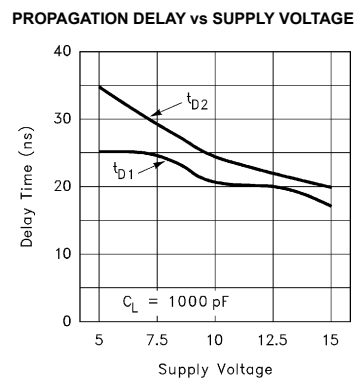
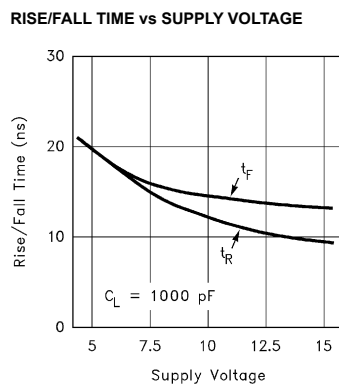
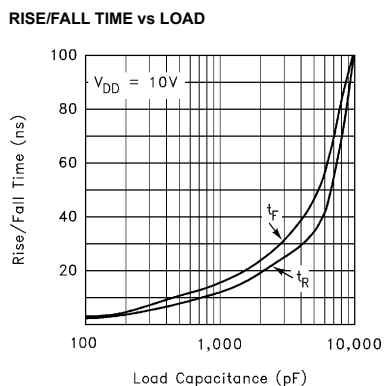
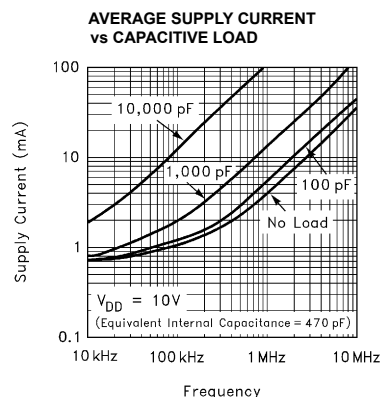
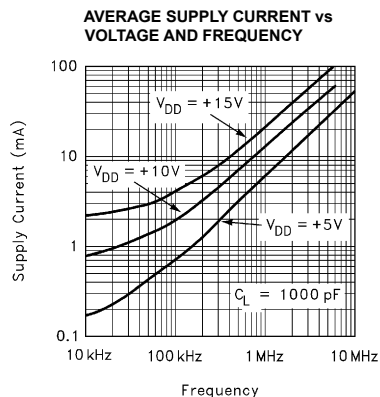
CASE:

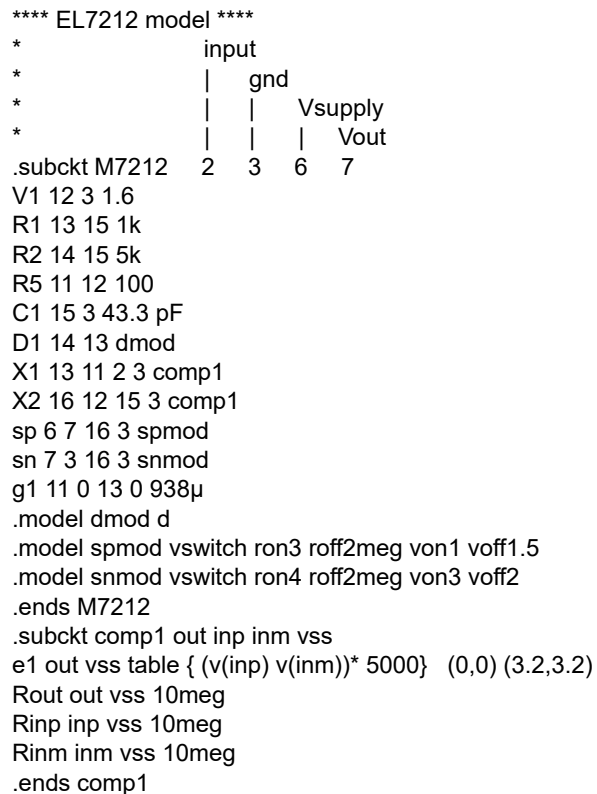
| Device | Input Level | Curve |
|--------|-------------|-------|
| EL7202 | GND         | A     |
| EL7202 | GND, V+     | B     |
| EL7202 | V+          | C     |
| EL7212 | GND         | C     |
| EL7212 | GND, V+     | D     |
| EL7212 | V+          | E     |
| EL7222 | GND         | B     |
| EL7222 | GND, V+     | C     |
| EL7222 | V+          | D     |

"ON" RESISTANCE vs SUPPLY VOLTAGE



## Typical Performance Curves (Continued)





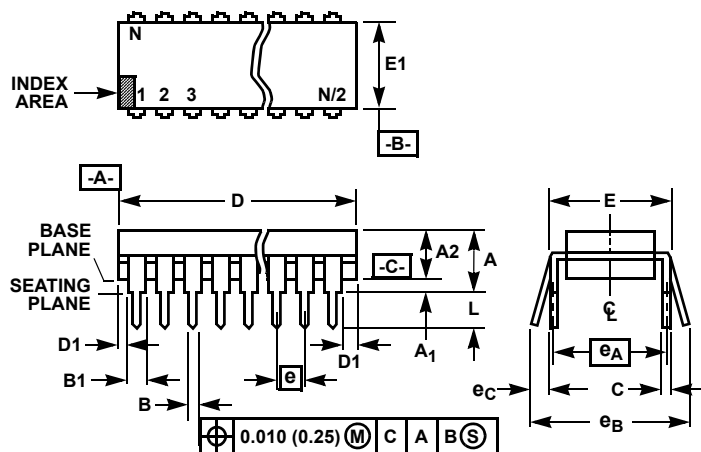
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## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please visit our website to make sure you have the latest revision.

| DATE         | REVISION | CHANGE                                                                                                                                                              |
|--------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Feb 18, 2020 | 2.01     | Updated ordering information table.<br>Added Revision History<br>Replaced POD MDP0031 with E8.3 POD.<br>Replaced POD MDP0027 with M8.15E POD.<br>Updated disclaimer |

## Package Outline Drawings



### NOTES:

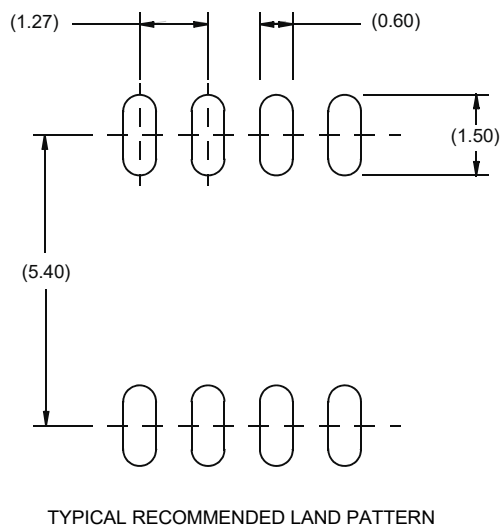
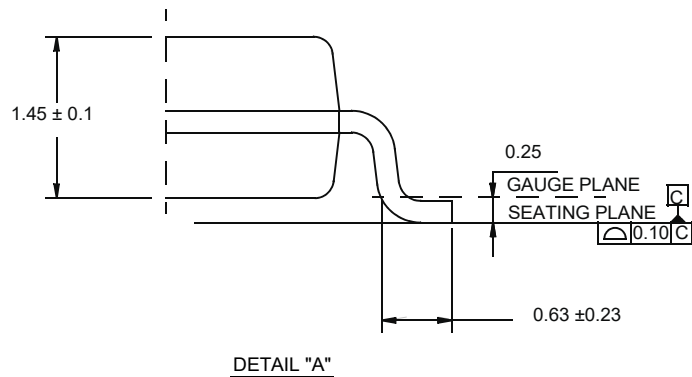
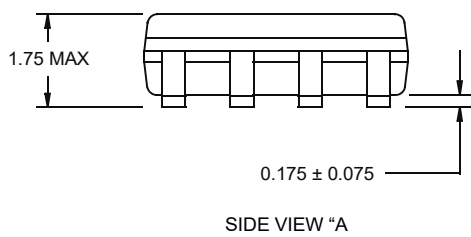
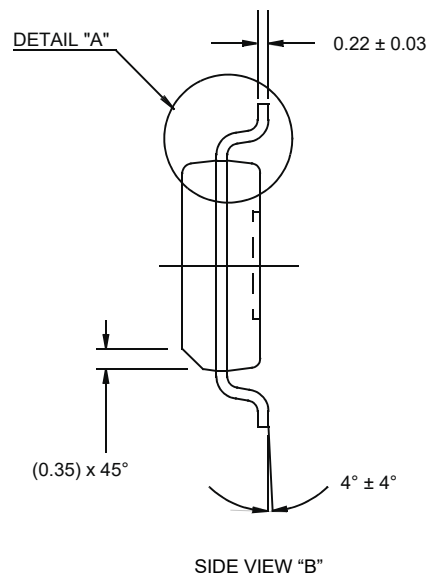
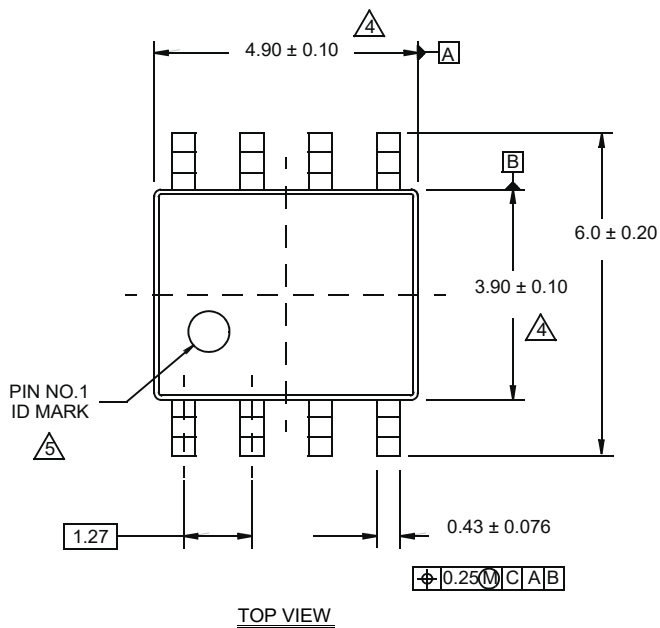
1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
4. Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
5. D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
6. E and  $e_A$  are measured with the leads constrained to be perpendicular to datum  $-C-$ .
7.  $e_B$  and  $e_C$  are measured at the lead tips with the leads unconstrained.  $e_C$  must be zero or greater.
8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
9. N is the maximum number of terminal positions.
10. Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

### E8.3 (JEDEC MS-001-BA ISSUE D) 8 LEAD DUAL-IN-LINE PLASTIC PACKAGE (PDIP)

| SYMBOL | INCHES    |       | MILLIMETERS |       | NOTES |
|--------|-----------|-------|-------------|-------|-------|
|        | MIN       | MAX   | MIN         | MAX   |       |
| A      | -         | 0.210 | -           | 5.33  | 4     |
| A1     | 0.015     | -     | 0.39        | -     | 4     |
| A2     | 0.115     | 0.195 | 2.93        | 4.95  | -     |
| B      | 0.014     | 0.022 | 0.356       | 0.558 | -     |
| B1     | 0.045     | 0.070 | 1.15        | 1.77  | 8, 10 |
| C      | 0.008     | 0.014 | 0.204       | 0.355 | -     |
| D      | 0.355     | 0.400 | 9.01        | 10.16 | 5     |
| D1     | 0.005     | -     | 0.13        | -     | 5     |
| E      | 0.300     | 0.325 | 7.62        | 8.25  | 6     |
| E1     | 0.240     | 0.280 | 6.10        | 7.11  | 5     |
| e      | 0.100 BSC |       | 2.54 BSC    |       | -     |
| $e_A$  | 0.300 BSC |       | 7.62 BSC    |       | 6     |
| $e_B$  | -         | 0.430 | -           | 10.92 | 7     |
| L      | 0.115     | 0.150 | 2.93        | 3.81  | 4     |
| N      | 8         |       | 8           |       | 9     |

Rev. 0 12/93

M8.15E  
8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE  
Rev 0, 08/09



NOTES:

1. Dimensions are in millimeters.  
Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
4. Dimension does not include interlead flash or protrusions.  
Interlead flash or protrusions shall not exceed 0.25mm per side.
5. The pin #1 identifier may be either a mold or mark feature.
6. Reference to JEDEC MS-012.

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(Rev.4.0-1 November 2017)

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